TOSHIBA Zener Diode Silicon Epitaxial Planar Type

MUZ Series

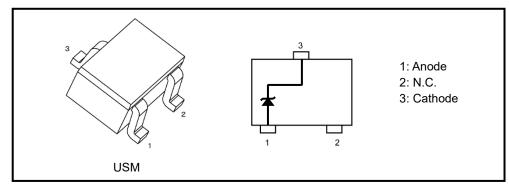
Applications

Voltage surge protection

Features

- Small package
- The typical voltage of Vz is accorded to E24 series

Packaging and Internal Circuit



Absolute Maximum Ratings 1 (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	PD ^{*1}	150	mW
	PD ^{*2}	600	mW
Junction temperature	Тј	150	°C
Storage temperature	T _{stg}	-55 to 150	°C

Absolute Maximum Ratings 2 (Note) (Unless otherwise specified, Ta = 25°C)

Type No.	Electrostatic discharge voltage *3		Peak pulse	Peak pulse Type No.		Electrostatic discharge voltage *3		Peak pulse	Peak pulse
	Contact	Air	power *4	current ^{*4}		Contact	Air	power ^{*4}	current ^{*4}
	V _{ESD} (kV)		P _{PK} (W)	IPP(A)		V _{ESD} (kV)		P _{PK} (W)	I _{PP} (A)
MUZ5V6	± 30		155	12	MUZ16V	± 30		200	5.5
MUZ6V2	± 30		175	11	MUZ20V	± 30		200	5
MUZ6V8	± 30		180	10	MUZ24V	± 30		200	4.5
MUZ8V2	± 30		200	8.5	MUZ30V	± 20		200	4
MUZ12V	± 30		200	7	MUZ36V	± '	12	200	3

- Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).
- *1: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 0.5 mm² x 3
- *2: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 645 mm²
- *3: according to IEC61000-4-2
- *4: according to IEC61000-4-5, tp = 8 / 20 μ s

Start of commercial production 2020-07

MUZ series Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

Type No.	Zener Voltage			Dynamic Impedance		Dynamic resistance	Clamp voltage	Total capacitance	Reverse Current		
• 2 (•)		Test Current	- <u>∠</u> ()	$R_{DYN}(\Omega)^{*1}$	V _C (V) ^{*1*2}	C _t (pF) ^{*3}	I _R (μA)				
	Min	Тур.	Max	I _Z (mA)	Max	I _Z (mA)	Тур.	Тур.	Тур.	Max	V _R (V)
MUZ5V6	5.3	5.6	6.0	5	30	5	0.16	9	125	1	3.5
MUZ6V2	5.8	6.2	6.6	5	30	5	0.21	10	105	2.5	5.0
MUZ6V8	6.4	6.8	7.2	5	30	5	0.27	13	88	1.5	5.5
MUZ8V2	7.7	8.2	8.7	5	30	5	0.37	16.5	67	0.1	7
MUZ12V	11.4	12	12.6	5	30	5	0.7	26	44	0.1	10
MUZ16V	15.3	16	17.1	5	35	5	0.5	27	35	0.1	14
MUZ20V	18.8	20	21.2	5	70	5	0.35	30.5	29	0.1	17.6
MUZ24V	22.8	24	25.6	5	70	5	0.6	36.5	26	0.1	19
MUZ30V	28.0	30	32.0	2	100	2	1.25	47.5	21	0.1	27
MUZ36V	34.0	36	38.0	2	100	2	2.6	63	18	0.1	32.5

*1: TLP parameters: $Z_0 = 50 \ \Omega$, $t_p = 100 \ ns$, $t_r = 300 \ ps$, averaging window: $t_1 = 30 \ ns$ to $t_2 = 60 \ ns$,

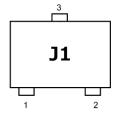
extraction of dynamic resistance using least squares fit of TLP characteristics between $I_{TLP1} = 16$ A and $I_{TLP2} = 30$ A. *2: $I_{TLP} = 16$ A

*3: VR = 0 V, f = 1 MHz

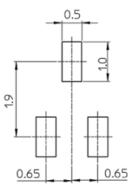
Marking List

Type No.	Marking	Type No.	Marking
MUZ5V6	J1	MUZ16V	J7
MUZ6V2	J2	MUZ20V	JA
MUZ6V8	J3	MUZ24V	JB
MUZ8V2	J4	MUZ30V	JC
MUZ12V	J6	MUZ36V	JD

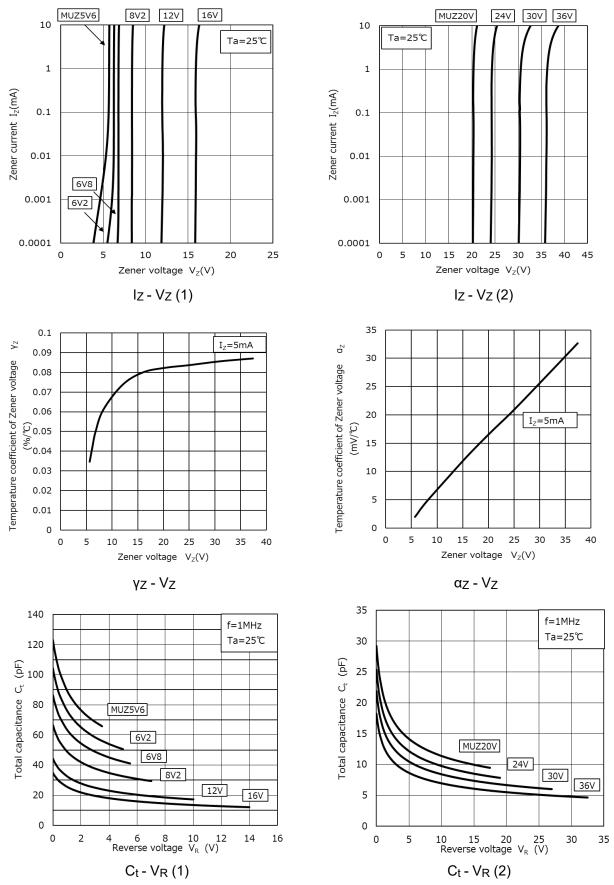
Marking (MUZ5V6)



Land Pattern Dimensions (for reference only) (Unit: mm)



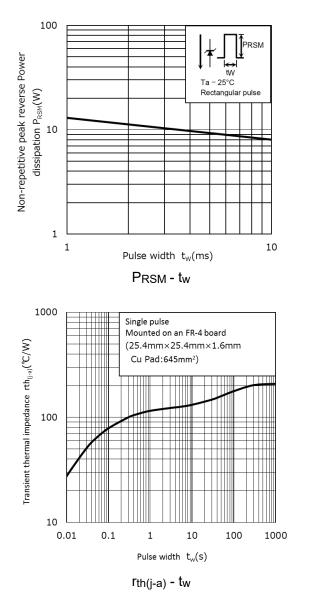
MUZ series Characteristics Curves (Note 1)



Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

Mounted on an FR-4 board (25.4mm × 25.4mm × 1.6mm Cu Pad:645mm²)

MUZ series Characteristics Curves (Note 1)



Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

700

600

500

400

300

200

100

0

0

25

50

75

Ambient temperature

PD - Ta

100

125

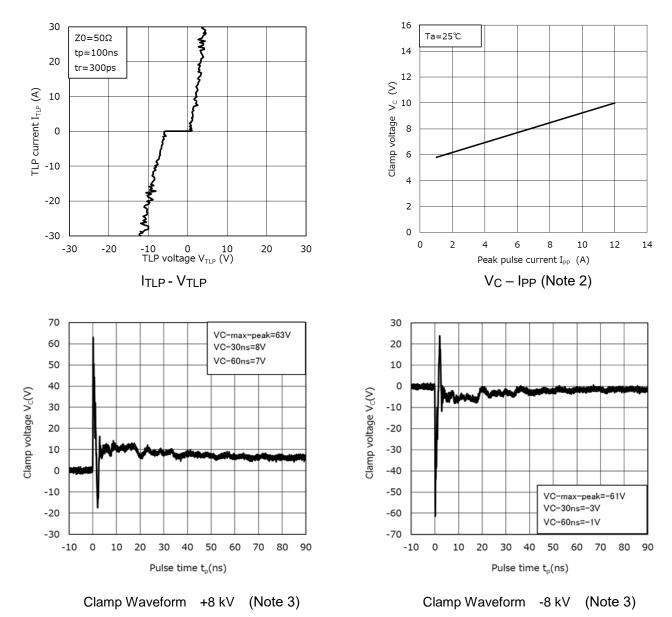
T_a(℃)

150

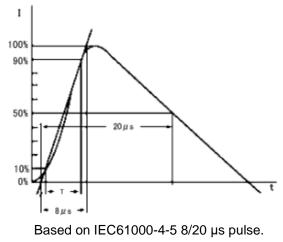
175

Power dissipation P_D (mW)

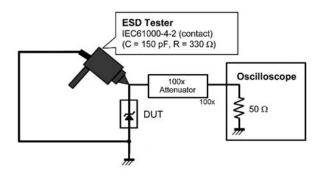
MUZ5V6 Characteristics Curves (Note 1)

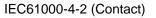




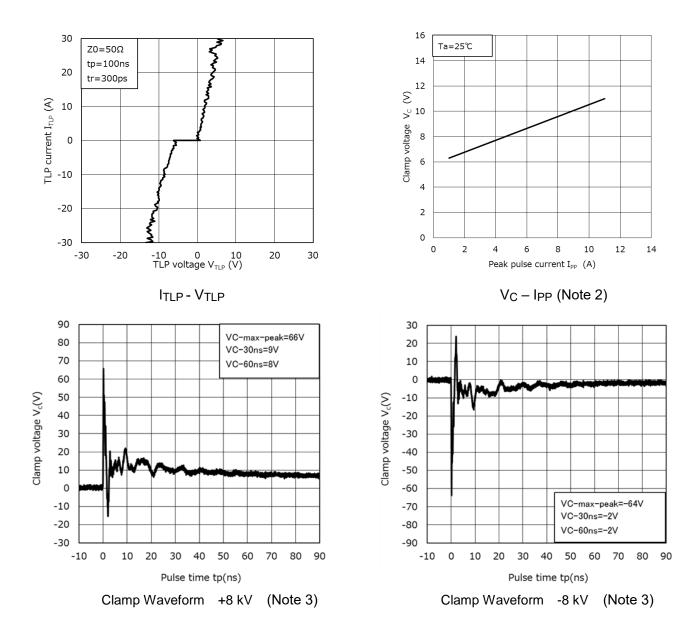


(Note 3) Clamp waveform measurement circuit

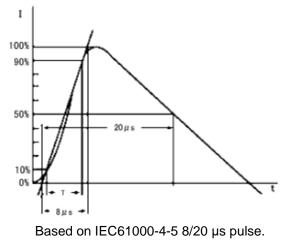




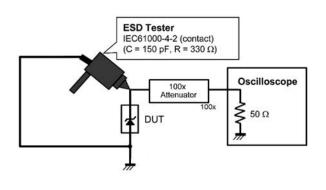
MUZ6V2 Characteristics Curves (Note 1)

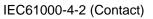




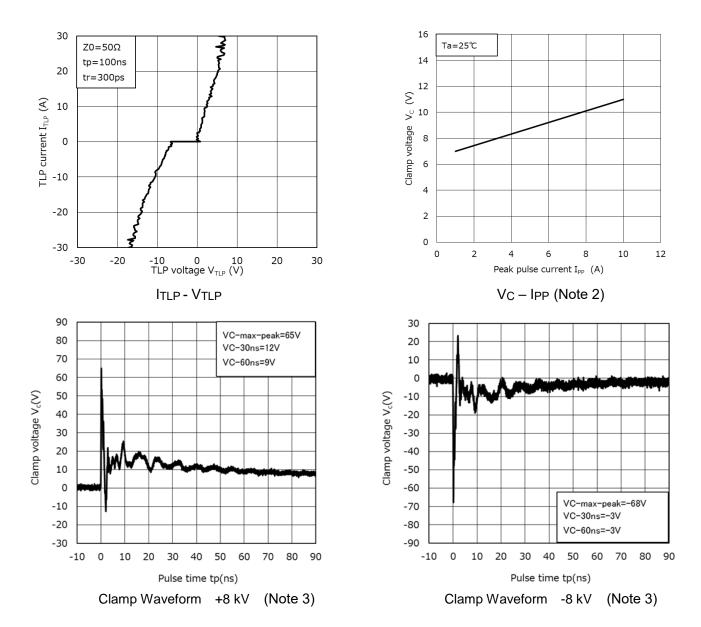


(Note 3) Clamp waveform measurement circuit

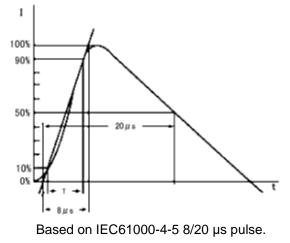




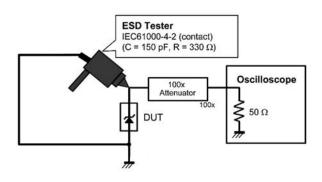
MUZ6V8 Characteristics Curves (Note 1)

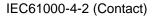




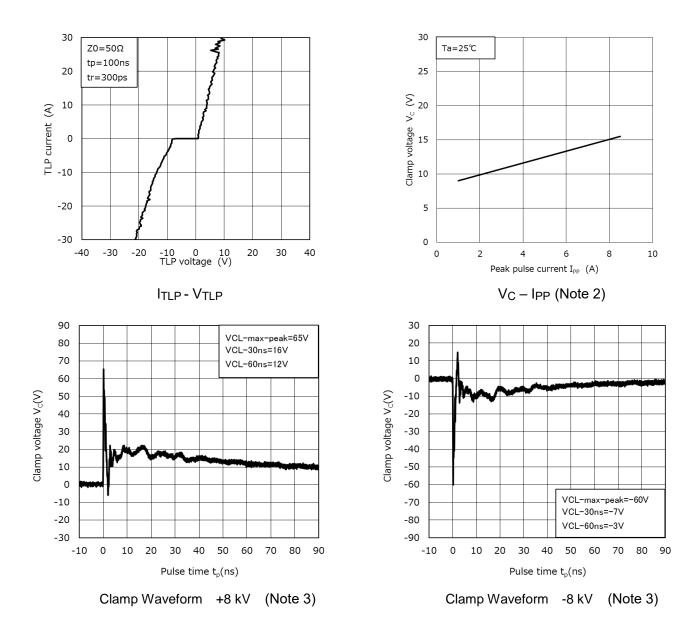


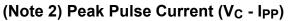
(Note 3) Clamp waveform measurement circuit

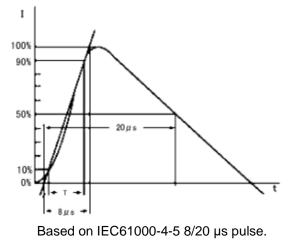




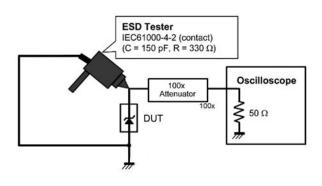
MUZ8V2 Characteristics Curves (Note 1)

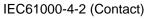




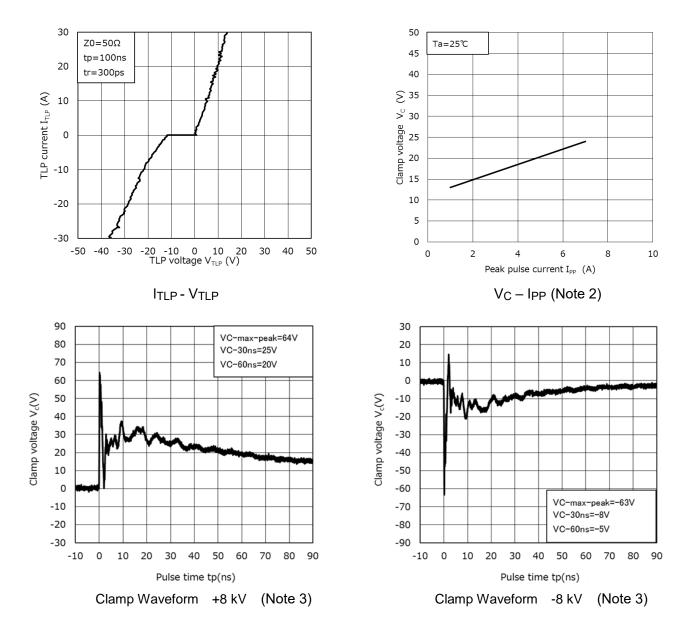


(Note 3) Clamp waveform measurement circuit

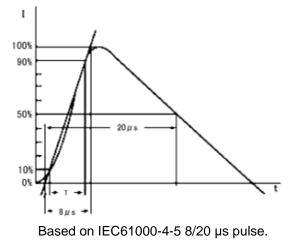




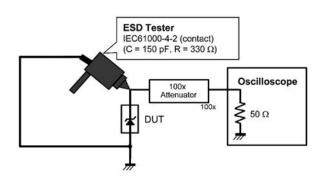
MUZ12V Characteristics Curves (Note 1)



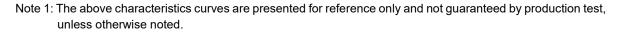




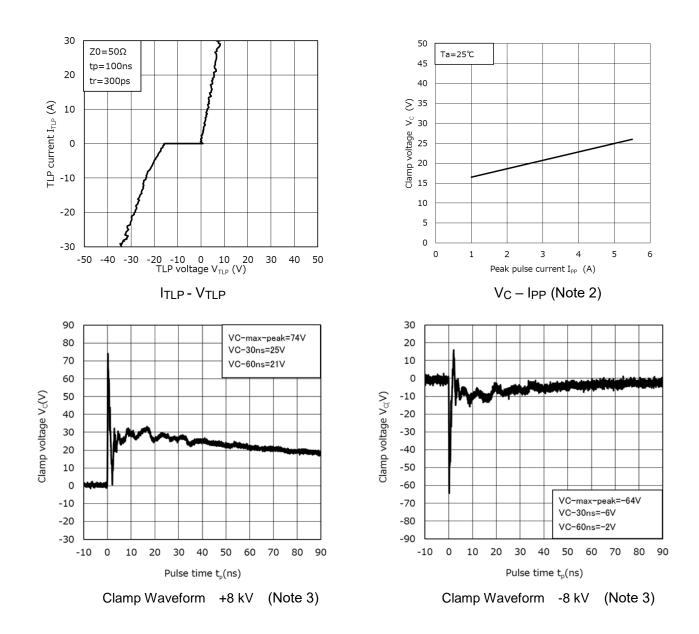
(Note 3) Clamp waveform measurement circuit



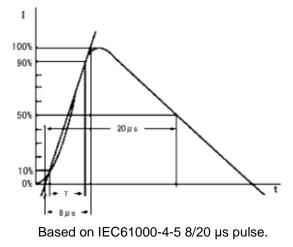
IEC61000-4-2 (Contact)



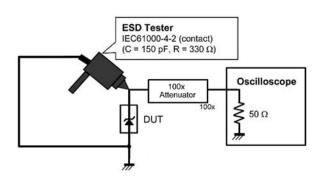
MUZ16V Characteristics Curves (Note 1)



(Note 2) Peak Pulse Current (V_C - I_{PP})

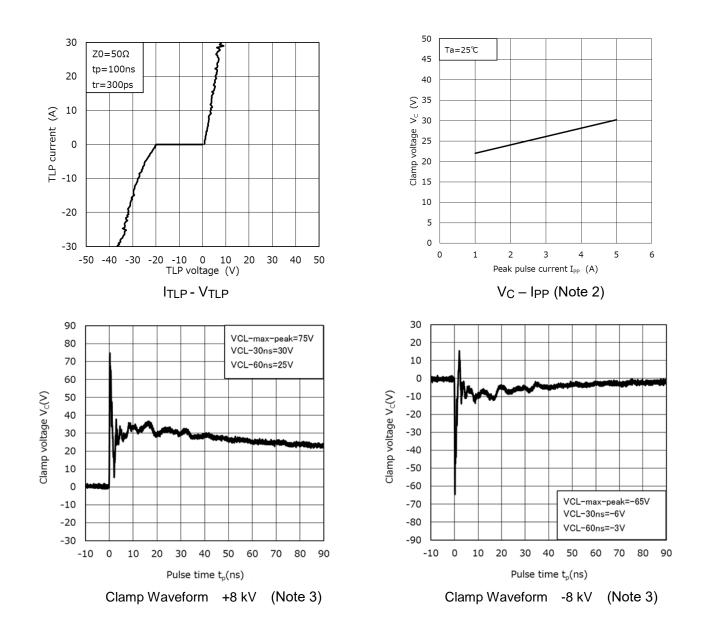


(Note 3) Clamp waveform measurement circuit

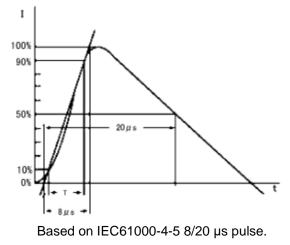


IEC61000-4-2 (Contact)

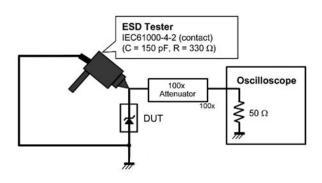
MUZ20V Characteristics Curves (Note 1)





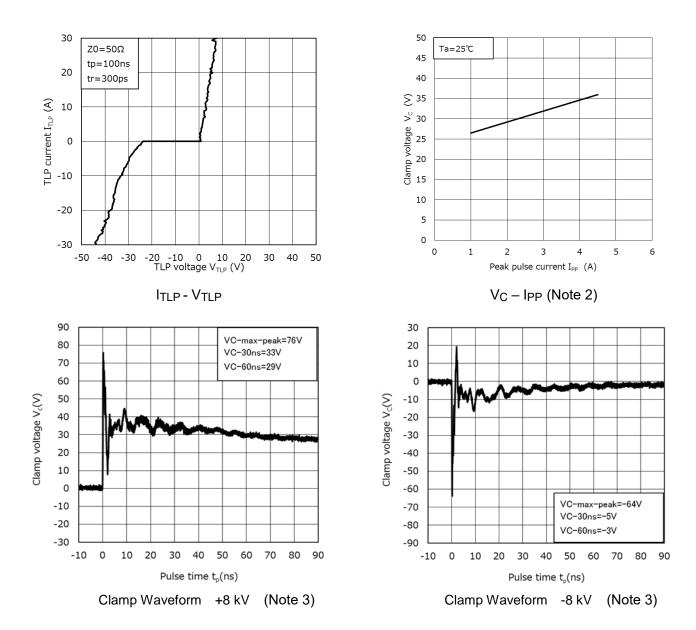


(Note 3) Clamp waveform measurement circuit

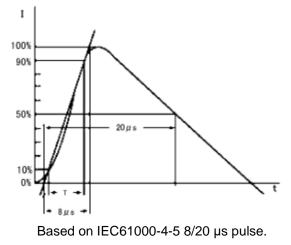


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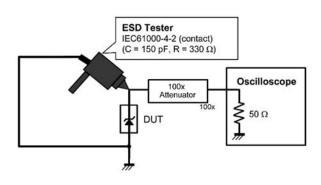
MUZ24V Characteristics Curves (Note 1)





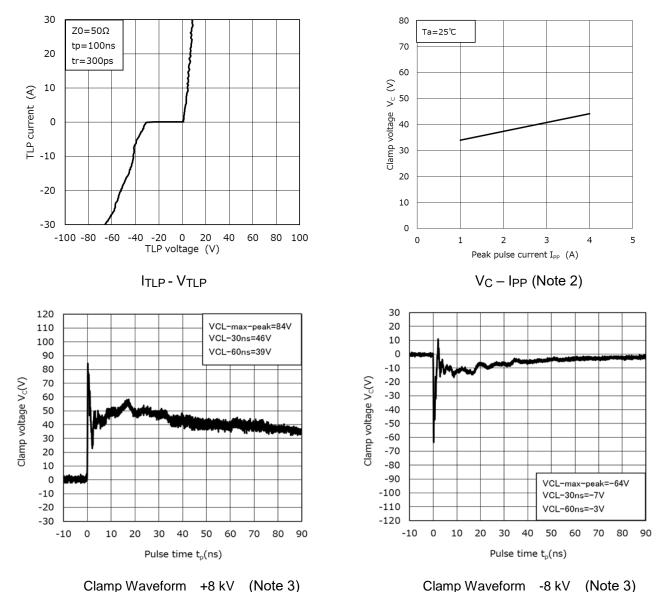


(Note 3) Clamp waveform measurement circuit

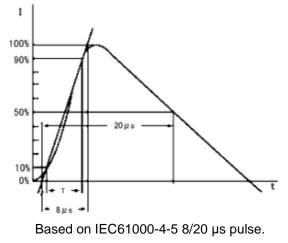


IEC61000-4-2 (Contact)

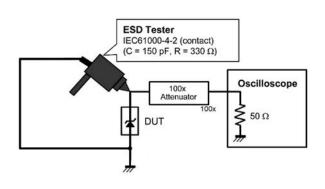
MUZ30V Characteristics Curves (Note 1)

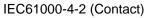




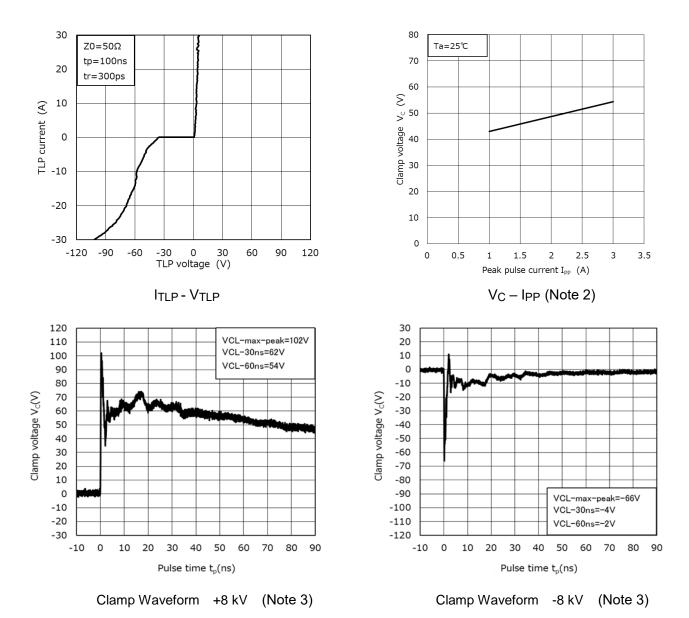


(Note 3) Clamp waveform measurement circuit

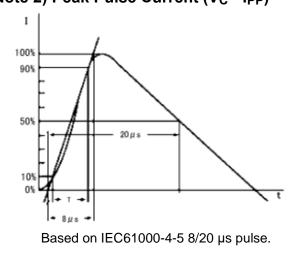




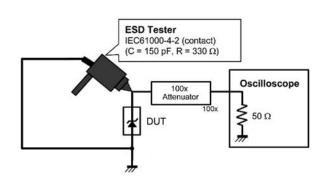
MUZ36V Characteristics Curves (Note 1)

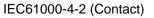






(Note 3) Clamp waveform measurement circuit

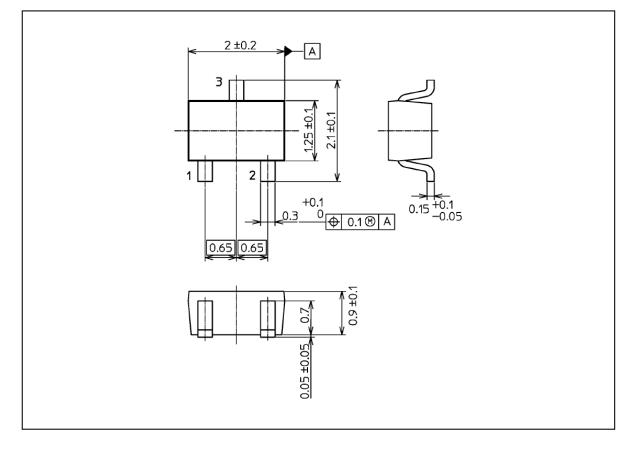






Package Dimensions

Unit: mm



Weight: 6.0 mg (typ.)

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